

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of: Ihl Hyun CHO

Serial No.: New Application      Group Art Unit: Not Yet Assigned

Filed: December 10, 2003      Examiner: Not Yet Assigned

Title: METHOD OF FORMING METAL LINE IN SEMICONDUCTOR DEVICE

**INFORMATION DISCLOSURE STATEMENT**

Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

December 10, 2003

Sir:

As a means of complying with the duty of disclosure under 37 CFR §1.56, and in accordance with 37 CFR §§1.97 and 1.98, Applicant(s), through the undersigned attorney, submits this Information Disclosure Statement. The patents, publications or other information submitted herewith are listed on the attached Form PTO-1449 and copies are attached.

In accordance with 37 CFR §1.97(b)(1) or (2), this Information Disclosure Statement is being filed either within three months of the filing date of the above-identified application, or within three months of the date of entry into the national stage of the above-identified application as set forth in 37 CFR §1.491. Accordingly, no fee is required.

Respectfully submitted,

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## LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

ATTY. DOCKET NO.: P69371US0 GROUP ART UNIT: Not Yet Assigned  
 SERIAL NO.: New Application FILING DATE: December 10, 2003  
 APPLICANT(S): Ihl Hyun CHO TODAY'S DATE: December 10, 2003

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## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	INT'L CLASS	SUB- CLASS	FILING DATE (If Appropriate)
_____	AA <u>6,323,121</u>	<u>11/27/01</u>	<u>Liu, et al.</u>	<u>H01L</u>	<u>21/4763</u>	<u>11/27/01</u>
_____	AB <u>6,319,809</u>	<u>11/20/01</u>	<u>Chang, et al.</u>	<u>H01L</u>	<u>21/44</u>	<u>7/12/00</u>
_____	AC <u>6,071,814</u>	<u>6/06/00</u>	<u>Jang, et al.</u>	<u>H01L</u>	<u>21/44</u>	<u>9/28/98</u>
_____	AD <u>6,417,096</u>	<u>7/09/02</u>	<u>Chen, et al.</u>	<u>H01L</u>	<u>21/4763</u>	<u>7/07/00</u>

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## FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION (YES) (NO)
_____	AE _____	_____	_____	_____	_____	____ _____
_____	AF _____	_____	_____	_____	_____	____ _____

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## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

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EXAMINER

DATE CONSIDERED

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).